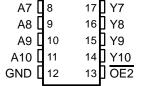
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- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 2 V at V_{CC} = 3.3 V, T_A = 25°C
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages

DB, DW, OR PW PACKAGE



description

This 10-bit buffer/bus driver is designed for 2.7-V to 3.6-V V_{CC} operation.

The SN74LVC827A provides a high-performance bus interface for wide data paths or buses carrying parity.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all ten outputs are in the high-impedance state. The SN74LVC827A provides true data at its outputs.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVC827A is characterized for operation from -40°C to 85°C.

FUNCTION TABLE

INPUTS			OUTPUT
OE1	OE2	Α	Y
L	L	L	L
L	L	Н	Н
Н	X	Χ	Z
Х	Н	Χ	Z



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

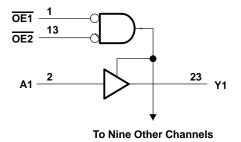
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logic symbol†

ΕN 13 OE2 23 Α1 **Y**1 3 22 **Y2** 4 21 **Y3** А3 5 20 Α4 Υ4 6 19 Α5 **Y5** 7 18 Y6 Α6 8 17 **Y7 A7** 16 Y8 **A8** 10 15 Α9 Y9 Y10 A10

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	–0.5 V to 6.5 V
Input voltage range, V _I (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, V _O	
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	–0.5 V to V_{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC}) (see Note 2)	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3): DB package	104°C/W
DW package	81°C/W
PW package	120°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. The value of V_{CC} is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51.

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
V	Cumphy voltage	Operating	2	3.6	V
Vcc	Supply voltage	Data retention only	1.5		V
VIH	High-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2	2	
V _{IL}	Low-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8	V
٧ı	Input voltage		0	5.5	V
٧o	Output voltage	High or low state	0	VCC	V
		3 state	0	5.5	V
ЮН	High-level output current	V _{CC} = 2.7 V		-12	mA
		V _{CC} = 3 V		-24	IIIA
lOL	Law law all autout auronat	V _{CC} = 2.7 V		12	mA
	Low-level output current	V _{CC} = 3 V		24	IIIA
Δt/Δν	Input transition rise or fall rate			10	ns/V
TA	Operating free-air temperature			85	°C

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PAR	AMETER	TEST C	v _{cc}	MIN	TYP†	MAX	UNIT		
		I _{OH} = -100 μA		2.7 V to 3.6 V	V _{CC} -0.2				
\ \/ a		I _{OH} = -12 mA		2.7 V	2.2			V	
VOH				3 V	2.4				
		I _{OH} = -24 mA		3 V	2.2				
		Ι _{ΟL} = 100 μΑ		2.7 V to 3.6 V			0.2	V	
VOL		I _{OL} = 12 mA		2.7 V			0.4		
		I _{OL} = 24 mA		3 V			0.55		
lį		V _I = 0 to 5.5 V		3.6 V			±5	μΑ	
l _{off}		V_I or $V_O = 5.5 V$		0			±10	μΑ	
loz		$V_0 = 0 \text{ to } 5.5 \text{ V}$		3.6 V			±10	μΑ	
Icc		$V_I = V_{CC}$ or GND	1- 0	261/			10		
		$3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{\ddagger}$	IO = 0	3.6 V		10		μΑ	
Δlcc		One input at V _{CC} – 0.6 V,	Other inputs at V _{CC} or GND	2.7 V to 3.6 V			500	μΑ	
<u></u>	Control	V. Vee or CND		3.3 V		5			
C _i	Data	V _I = V _{CC} or GND		3.3 V		4		pF	
Co		$V_O = V_{CC}$ or GND		3.3 V		7		pF	

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. ‡ This applies in the disabled state only.



SN74LVC827A 10-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	
^t pd	А	Υ	1	6.7		7.1	ns
^t en	ŌE	Υ	1	7.3		8.5	ns
^t dis	ŌE	Y	1.8	6.7		7.3	ns
t _{sk(o)} †				1			ns

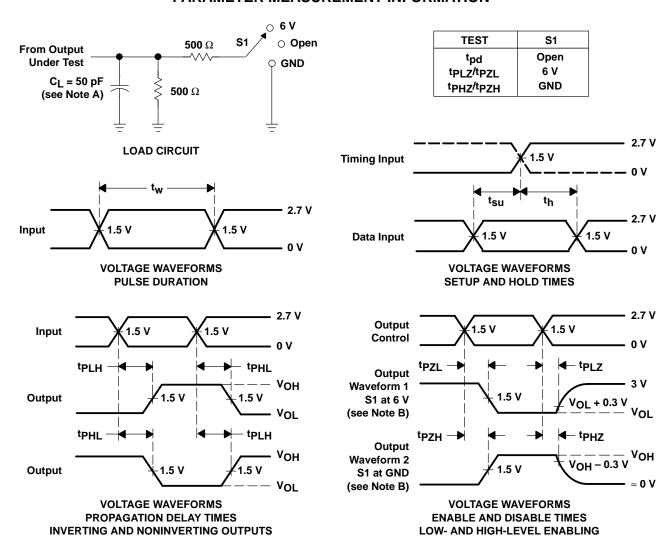
[†] Skew between any two outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

operating characteristics, V_{CC} = 3.3 V, T_A = 25°C

PARAMETER			TEST C	ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per buffer/driver	Outputs enabled	C _L = 0,	f = 10 MHz	24	nE.
		Outputs disabled			5	pF



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_Q = 50 \Omega$, $t_f \leq 2.5 \text{ ns.}$
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

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